

# CNX200 – IP500® Module

## Low Power Wireless Networking Dual-Band Module



CoreNetiX offers wireless communication technologies and solutions for low-power smart sensor networks.

### KEY FEATURES

- Simultaneous Dual-Band Operation
- Cost-Optimized Multi-Standard Module for IoT
- Conform to IEEE 802.15.4-2006
- EN54-25, VdS compliant hardware/IP500® Stack
- On Board AES 128-Bit Encryption Accelerator
- Easy to Integrate into your Products
- Interfaces: Serial, GPIO, Analog Input/ Output
- Support for Capacitive Touch Interface
- Compact Dimensions: 15.0 mm x 40.0 mm

### DESCRIPTION

The CNX200 is worldwide the first TRUE dual-band module supporting simultaneous communication in the sub-GHz and 2.4GHz frequency bands addressing the increasing performance needs of customers looking for cost effective multi-protocol stack connectivity solutions.

CNX200 complies with the latest IEEE802.15.4-2006. The CNX200 offers O-QPSK modulation in the European, American, India, Japanese bands up to the worldwide ISM bands.

CNX200 is designed to address the challenging demands of the IP500® standard for secured and fail-safe communication.

Dedicated CNX200 solutions can also support the EN54-25 and VdS requirements for fire and safety.

The CNX200 dual band module is the ideal platform for OEM's looking for a versatile platform, enabling them to design-in wireless capabilities into their products for Smart Metering, Smart Lighting, Smart Home, Smart Energy, Automation and Industrial Solutions. The CNX200 is worldwide the only module offering simultaneous operation in the sub-GHz and 2,4 GHz bands for IP500® and other industrial / security/ access control standards.

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## Low Power Wireless Networking Dual-Band Module

### SPECIFICATION

#### GENERAL

<b>Power Supply Voltage</b>	2.7 – 3.6 V
<b>Current Consumption</b>	TX on: 78 mA @ +14 dBm RF Output Power RX on: 41 mA, Sleep Mode: < 5 $\mu$
<b>Dimensions</b>	15 mm x 40 mm
<b>Temperature Range</b>	-40°C to +85°C (Operating)
<b>Weight</b>	< 1.7 g
<b>Antenna</b>	2 x U.FL Coaxial Connector
<b>Supported Standards</b>	IEEE 802.15.4-2006
<b>Interfaces</b>	UART, GPIO, Audio Bit Stream, ADC

#### PROCESSOR / MODULE

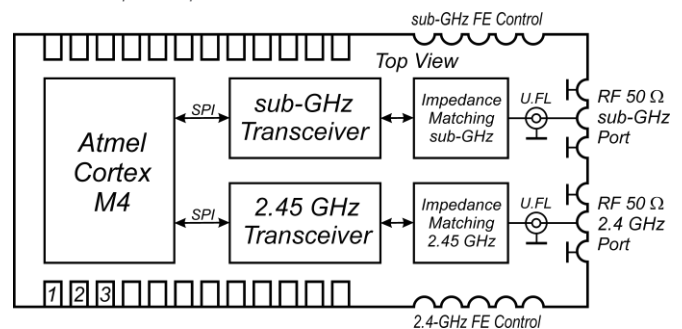
<b>Microprocessor</b>	Atmel Cortex M4, Pico Power Technology
<b>Memories</b>	Flash 512 kByte, RAM 64 kByte
<b>Modulation</b>	IEEE 802.15.4-2006
<b>Hardware Accelerators</b>	AES-128 Encryption Engine, CRC Unit

#### RF PERFORMANCE

<b>Receiver Sensitivity</b>	Down to -115 dBm at 100kbps
<b>Over-Air Data Rate</b>	100kbps, 1.2Mbps
<b>RF Output Power</b>	Up to +14 dBm (50 Ohm Load)
<b>Bands</b>	868MHz (EU), 920MHz (JP), 915MHz (US), 2.4GHz World
<b>World-Wide ISM Band</b>	2400-2483.5 MHz

#### SIMULTANEOUS OPERATION AT sub-GHz AND 2.4 GHz

*Note: All data are preliminary data and subject to change during development phase*



#### IP500® Protocol Stack

Module Application	Application Layer
BACnet	Presentation Layer
UDP	Transport Layer
ICMP	Network Layer
IPv6	
6LowPAN	Link Layer
Forwarding	
802.15.4 MAC	
802.15.4 PHY	Physical Layer

#### PIN LIST

Pin	Description	Pin	Description	Pin	Description
1	GROUND	15	RF GROUND	29	GROUND
2	VCC	16	ANT24_1	30	GPIO 08
3	GROUND	17	RF GROUND	31	GPIO 09
4	ADC_REF	18	RF GROUND	32	GPIO 10
5	GPIO 01	19	ANT24_2	33	TxD/TWCK
6	GPIO 02	20	RF GROUND	34	RxD/TWD
7	GPIO 03	21	RF GROUND	35	GROUND
8	GPIO 04	22	ANT09_2	36	SWCLK
9	GPIO 05	23	RF GROUND	37	SWDIO
10	GPIO 06	24	RF GROUND	38	/RESET
11	GPIO 07	25	ANT09_1	39	TRACESWO
12	GROUND	26	RF GROUND	40	GROUND
13	FEB24	27	FEA09		
14	FEA24	28	FEB09		